## AM4953P

## **Analog Power**

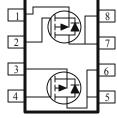
## Dual P-Channel 30-V (D-S) MOSFET

These miniature surface mount MOSFETs utilize High Cell Density process. Low  $r_{DS(on)}$  assures minimal power loss and conserves energy, making this device ideal for use in power management circuitry. Typical applications are PWMDC-DC converters, power management in portable and battery-powered products such as computers, printers, battery charger, telecommunication power system, and telephones power system.

- Low r<sub>DS(on)</sub> Provides Higher Efficiency and Extends Battery Life
- Miniature SO-8 Surface Mount Package Saves Board Space
- High power and current handling capability
- Extended VGS range (±25) for battery pack applications

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$r_{DS(on)} m(\Omega)$	I <sub>D</sub> (A)		
-30	$52 @ V_{GS} = -10V$	-5.2		
	$89 @ V_{GS} = -4.5V$	-4.0		





ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C UNLESS OTHERWISE NOTED)					
Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V <sub>DS</sub>	-30	V	
Gate-Source Voltage		V <sub>GS</sub>	±25	v	
Continuous Drain Current <sup>a</sup>	T <sub>A</sub> =25°C	Τ_	±5.2		
	$T_{A}=25^{\circ}C$ $T_{A}=70^{\circ}C$	чD	±4.2	А	
Pulsed Drain Current <sup>b</sup>		I <sub>DM</sub>	±30		
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	-1.6	А	
Power Dissipation <sup>a</sup>	T <sub>A</sub> =25°C	P_	2.1	W	
	$T_{A}=25^{\circ}C$ $T_{A}=70^{\circ}C$	1 D	1.3	vv	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 150	°C	

THERMAL RESISTANCE RATING	S			
Parameter		Symbol	Maximum	Units
Maximum Junction-to-Case <sup>a</sup>	t <= 5 sec	$R_{\theta JC}$	40	°C/W
Maximum Junction-to-Ambient <sup>a</sup>	t <= 10 sec	$R_{\theta JA}$	60	°C/W

Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

SPECIFICATIONS ( $T_A = 25^{\circ}C$ UNLESS OTHERWISE NOTED)							
Parameter	Southal	Test Conditions	Limits			Unit	
rarameter	Symbol	Test Conditions	Min	Тур	Max	Omt	
Static							
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \text{ uA}$	-1				
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 25 V$			±100	nA	
Zero Gate Voltage Drain Current	Т	$V_{DS} = -24 V, V_{GS} = 0 V$			-1	11.4	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -24 V, V_{GS} = 0 V, T_J = 55^{\circ}C$			-5	uA	
On-State Drain Current <sup>A</sup>	I <sub>D(on)</sub>	$V_{DS} = -5 V, V_{GS} = -10 V$	-30			Α	
	r <sub>DS(on)</sub>	$V_{GS} = -10 \text{ V}, I_D = -5.2 \text{ A}$			52	mΩ	
Drain-Source On-Resistance <sup>A</sup>		$V_{GS} = -4.5 \text{ V}, I_D = -4.0 \text{ A}$			89		
Forward Tranconductance <sup>A</sup>	$g_{\rm fs}$	$V_{\rm DS}$ = -15 V, $I_{\rm D}$ = -5.2 A		19		S	
Diode Forward Voltage	V <sub>SD</sub>	$I_{\rm S} = -2.1 \text{ A}, V_{\rm GS} = 0 \text{ V}$		-0.7		V	
Dynamic <sup>b</sup>							
Total Gate Charge	Qg	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V},$ $I_D = -5.2 \text{ A}$		15		nC	
Gate-Source Charge	Q <sub>gs</sub>			2.2			
Gate-Drain Charge	Q <sub>gd</sub>			1.7			
Turn-On Delay Time	t <sub>d(on)</sub>			10			
Rise Time	t <sub>r</sub>	$V_{DD}$ = -15 V, $R_L$ = 15 $\Omega$ , ID = -1 A,		2.8		nS	
Turn-Off Delay Time	t <sub>d(off)</sub>	VGEN = -10 V, $RG = 6\Omega$		53.6			
Fall-Time	t <sub>f</sub>	1		46			

Notes

(C)

- a. Pulse test:  $PW \le 300$  us duty cycle  $\le 2\%$ .
- b. Guaranteed by design, not subject to production testing.

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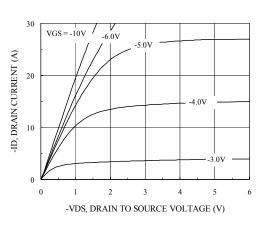




Figure 1. On-Region Characteristics

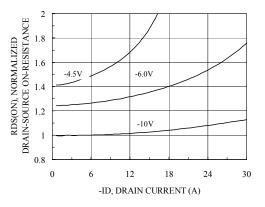
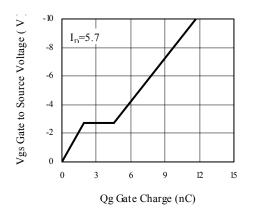


Figure 3. On Resistance Vs Vgs Voltage



**Figure 5. Gate Charge Characteristics** 

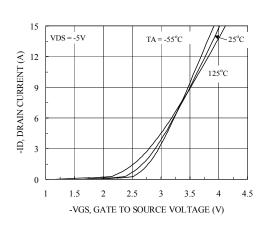
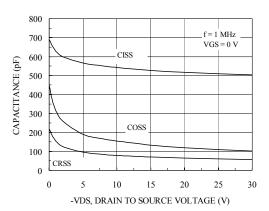


Figure 2. Body Diode Forward Voltage Variation with Source Current and Temperature



**Figure 4. Capacitance Characteristics** 

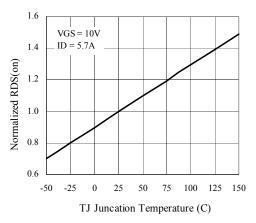
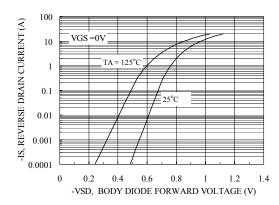
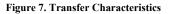


Figure 6. On-Resistance Variation with Temperature



## Typical Electrical Characteristics (P-Channel)



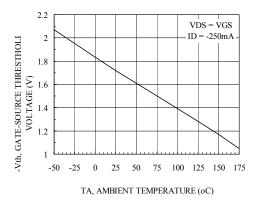


Figure 9. Vth Gate to Source Voltage Vs Temperature

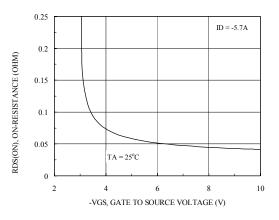


Figure 8. On-Resistance with Gate to Source Voltage

